PRODUCT SPECIFICATIONS

For Custom	er:	: APPR	OVAL FOR SP	ECIFICA	TION
Customer Model No			: APPROVAL	FOR SA	MPLE
Module No.	: YH05001	4A2-40	Date :	2013.12	.10
			V	ersion :	
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Approve	ed by		Comme	ent 	
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2. Revision Record

Date	Rev.No.	Page	Revision Items	Prepared
2013.12.10	V0		The first release	Wang



3. General Specifications

YH050014A2-40 is a TFT-LCD module. It is composed of a TFT-LCD panel, driver IC, FPC, a back light unit. The 5.0" display area contains 480x 272pixels and can display up to 16M colors. This product accords with RoHS

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	16M		1
Viewing Direction	6:00	O'Clock	
Operating temperature	-20~+70	C	
Storage temperature	-30~+80	°C	
Module size	Refer to outline drawing	mm	2
Active Area(W×H)	110.88X62.832	mm	
Number of Dots	480×272	dots	
Power Supply Voltage	3.3	V	
Outline Dimensions	Refer to outline drawing	-	
Backlight	6X2-LEDs (white)	pcs	

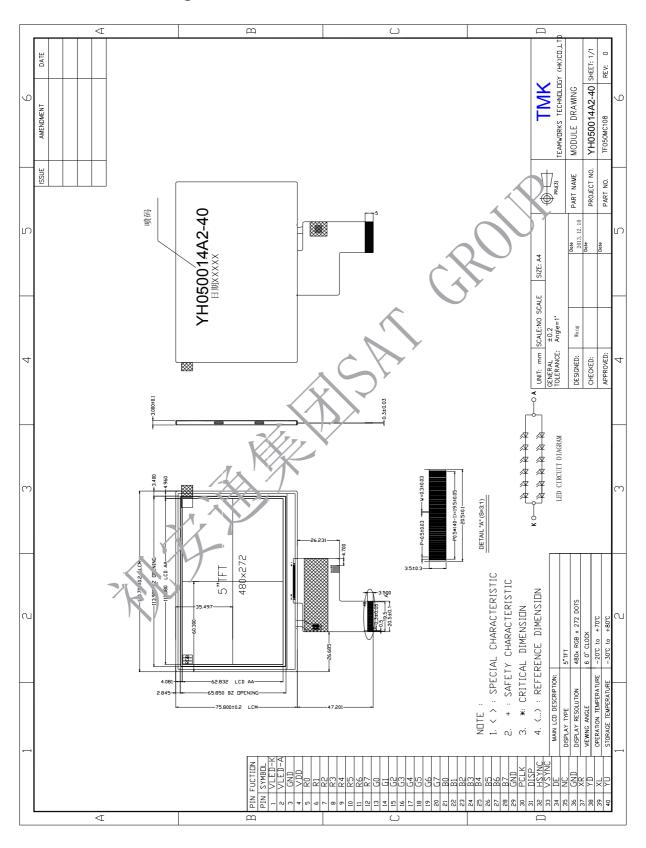
environmental criterion.

Note 1: Color turie is slightly changed by temperature and driving voltage.

Note 2: Without FPC and Solder.

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4. Outline Drawing





5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25℃)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V_{CC}	-0.3	3.6	V	
Logic Signal Input /Output Voltage	V _{IOVCC}	-0.3	V _{CC} +0.5	V	1, 2
Power Supply Voltage for LCD	Vop	0	3.6	X	1, 2
Current of LED	ILED	0	20	mA	

Notes:

- If the module is above these absolute maximum ratings. It may be conve permanently damaged.
 Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. $V_{CC} > V_{SS}$ must be maintained.
- 3. Please be sure users are grounded when handing LCD Module.

5.2 Environmental Absolute Naximum Ratings.

Item	Stor	age	Operating		Note	
Item	MIN.	MAX.	MIN.	MAX.	14010	
Ambient Temperature	-30°C	80°C	-20°C	70°C	1,2	
Humidity	-	-	-	-	3	

- 1. The response time will become lower when operated at low temperature.
- 2. Background color changes slightly depending on ambient temperature.

The phenomenon is reversible.

3. Ta<=40°C:85%RH MAX.

Ta>=40°C:Absolute humidity must be lower than the humidity of 85%RH at 40°C.



6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics(Vss=0V ,Ta=25°C)

Paramet	ter	Symbol	Condition	Min	Тур	Max	Unit	Note
Power sup	pply	VCC	Ta=25°C	2.6	3.3	3.6	V	
Input	'H'	V _{IH}	V _{CC} =2.8V	0.8V _{CC}	-	V _{CC}	V	
voltage	'L'	V _{IL}	V _{CC} =2.8V	0	-	0.2V _{CC}	V	
Current Consumption		I _{CC1}	Normal mode	-	-	20	mA	2
		I _{CC2}	Sleep mode	-	0.03	0.09	mA	2

Note:

1:When an optimum contrast is obtained in transmissive mode.

2: Tested in 1×1 chessboard pattern.



6.2 LED backlight specification(VSS=0V ,Ta=25°C)

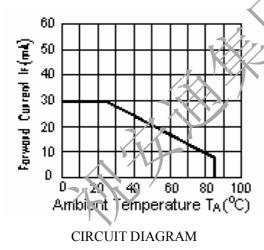
Ite	em	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply	voltage	-	-	-	19.2	-	٧	1
Supply	current	I _f	-	-	40	-	mA	2
Forward	Normal	I _{pn}	6X2-chip	-	40	-)a	
current	Dimming	l _{pd}	Serial	-	-	1	mA	

Note:

- 1: VLED=VLED(+)-VLED(-).
- 2:The current of LED is 20mA.

A LED drive in constant current mode is recommended.

3: LED power consumption is around 0.132W



ILED VS TEMP



6.3 Interface signals

Pin No.	Symbol	I/O	Function
1	VLED-	1	LED back light(Cathode)
2	VLED+	I	LED back light(Anode)
3	GND		GND
4	VDD	I	Power supply
5-12	R0~R7	I	Red data bus
13-20	G0~G7	I	Green data bus
21-28	B0~B7	I	Blue data bus
29	GND		GND
30	PCLK	I	Data clock
31	DISP	I	Standby mode select pin
32	HSYNC	I	Line SYNC signal
33	VSYNC	I	Frame SYNC signal
34	DE	I	Data enable pin
35	NC		NC
36	GND		GND
37	XR	0	
38	YD	0	
39	XL	0	Touch Fenel Control pin
40	YU	0	

7. Optical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Brightness	Вр	<i>θ</i> =0°	-	200	-	Cd/m ²	1
Uniformity	⊿Bp	Ф=0°	70	80	-	%	1,2
	3:00		-	70	-		
Viewing	6:00	0:>10	-	70	-		0
Angle	9:00	- Cr≥10	-	70	^	Deg	3
	12:00		-	50		\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\	
Contrast Ratio	Cr	<i>θ</i> =0°	350	500		-	4
Response Time	Trt	Ф=0°	-	20	-	ms	5
	w x		0.278	0.298	0.318	-	
	y	X	0.307	0.327	0.347	-	
	R	-7/77-	0.585	0.605	0.625	-	
Color of CIE	у		0.311	0.331	0.351	-	
Coordinate	G X	θ =0°	0.269	0.289	0.309	-	1,6
20	У	Ф=0°	0.526	0.546	0.566	-	
		1	0.121	0.141	0.161	-	
	В у	-	0.109	0.129	0.149	-	
NTSC Ratio	s		-	50	-	%	

Note: The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ8mm)

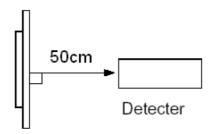
Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25℃.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while

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backlight turning on.

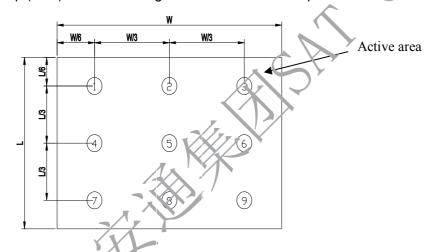


Note 2: The luminance uniformity is calculated by using following formula.

∠Bp = Bp (Min.) / Bp (Max.)×100 (%)

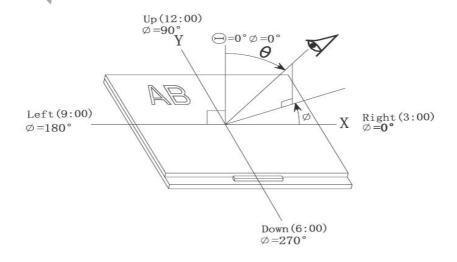
Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.



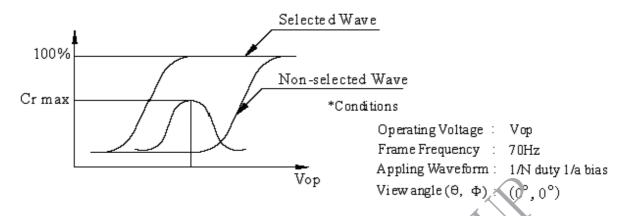
Note 3: The definition of viewing angle:

Refer to the graph below marked by θ and Φ



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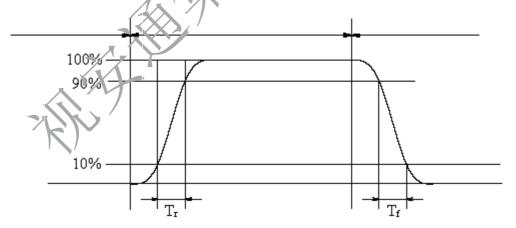
Note 4: Definition of contrast ratio.(Test LCD using DMS501)



$$Contrast \ ratio(Cr) = \frac{Brightness \ of \ selected \ dots}{Brightness \ of \ non-selected \ dots}$$

Note 5: Definition of Response time. (Test LCD using DM2501):

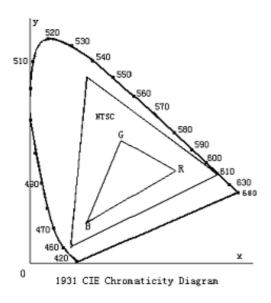
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as perove.



The definition of response time

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Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.

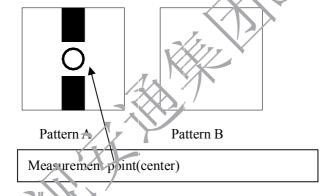


Color gamut:

 $S = \frac{area of RGB triangle}{area of NTSC triangle} \times 100\%$

Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern P Brightness | /pattern A Brightness*100



Electric volume value=3F+/-3Hex

8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
		80°C±2°C 96H	1. After testing,
1	High Temperature Storage	Restore 2H at 25°C	cosmetic and electrical
		Power off	defects should not
		-30°C±2°C 96H	happen.
2	Low Temperature Storage	Restore 2H at 25°C	2. Total current
		Power off	consumption should

		70°C±2°C 96H	not be more than twice
3	High Temperature Operation	Restore 2H at 25°C	of initial value.
		Power on	
		-20°C±2°C 96H	
4	Low Temperature Operation	Restore 4H at 25°C	
		Power on	
5	High Temperature/Humidity	60°C±2°C 90%RH 96H	
5	Operation	Power on	
		_30°C	
		30min 5min 30min	
6	Temperature Cycle		
		after 5 cycle, Restore 2H at 25°C	
		Power off	
7	Vibration Test	10Hz~150Hz, 100m/s², 120min	
			Not allowed cosmetic
8	Shock Test	Half- sine wave,300m/s ² ,11ms	and electrical defects.
	OHOUR IEST	Tian- sine wave, south's , Tims	
9	ESD Test	Air discharge:+/-8r V	
9	ESD 162[Contact discharge:4KV	

Note: Operation: Supply 2.8V for logic system.

The inspection terms after reliability test, as below

ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

9 Quality level

9.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects(such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

9.2 Definition of inspection range

For dot defect of TFT LCD which is not smaller than 3 inches, dividing three areas to make a judgment (according to figure 1).

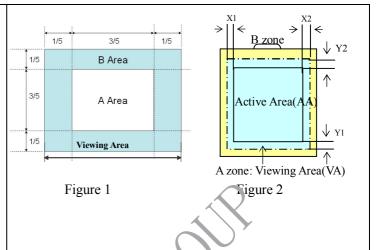
A area: center of viewing area

B area: periphery of viewing area

C area: Outside viewing area

For other defects, dividing two areas to make a judgment (according figure 2).

A zone : Inside Viewing area B zone : Outside Viewing area



9.3 Inspection items and general notes

	spootion itomo ana gonorai ne			
General notes	be determined by mutual agreemer 2. iewing area should be the area w 3.Limit sample should be prior to th 4.Viewing judgment should be unde 5.Inspection conditions Inspection distance: 250 mm (fro	which TIANMA quarantees. is Inspection standard. er static pattern		
	Pinhole, Bright spot, Black spot, White spot, Black line, White Line, Foreign particle, Bubble	The color of a small area is different from the remainder. The phenomenon doesn't change with voltage		
	Contrast variation	The color of a small area is different from the remainder. The phenomenon changes with voltage		
Inspection	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or between polarizer and glass		
items	Dot defect (TFT LCD)	The pixel appears bright or dark abnormally when display		
	Functional defect	No display, Abnormal display, Open or missing segment, Short circuit, False viewing direction		
	Glass defect	Glass crack, Shaved corner of glass, Surplus glass		
	PCB defect	Components assembly defect		

9.4 Outgoing Inspection level

Outgoing Inspection	Inspection conditions	Inspection					
standard	moposion conditions	Min.	Max.	Unit	IL	AQL	

Major Defects	See 8.3 general notes	See 8.5	II	0.065	
Minor Defects See 8.3 general notes		See 8.5	П	0.065	
Note: Sampling standard conforms to GB2828					

9.5 Inspection Items and Criteria

Inspection items			Judgment standard				
				Category	Acceptable number		
				Category	A zone	B zone	
	Black spot, White spot,	$ \begin{array}{c c} & b \\ & \downarrow \\ & \downarrow \\ & \Phi = (a+b)/2 \text{(mm)} \end{array} $	Α	Ф<=0.20	Neglected	Neglected	
			В	0.20<Ф<=0.25	3	Neglected	
1	Pinhole, Foreign Particle, Particle		С	0.25<Φ<=0.3	2	Neglected	
	in or on glass, Scratch on glass		D	0.3<Φ<≌0.4	1	3	
	Cordion on glass	(a/b<2.5)	E	0.4<Ф<=0.5	0	2	
			70	ial aefective point(B,C)	1	-	
		and	Α	W<=0.03	Neglected	Neglected	
	Black line, White line, and Particle Between		В	0.03 <w<=0.05 L<=3.0</w<=0.05 	3	Neglected	
2 Be Po			С	0.05 <w<=0.1 L<=3.0</w<=0.1 	2	Neglected	
	Polarizer and glass, Scratch on glass		D	0.05 <w<=0.1 L<=4.0</w<=0.1 	1	3	
	R		Е	W>0.1 L>4.0	0	2	
				tal defective point(B,C)	1	-	
3	Bright spot		any size		none	none	
	Contrast variation		Α	Ф<0.2	Neglected		
4			В	0.2<Ф<=0.3	2	Nogle start	
			С	0.3<Ф<=0.4	1	Neglected	
			D	0.4<Ф	0		
			То	tal defective point(B,C)	3		

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5	Bubble inside cell			any size	none	none	
	Polarizer defect	Scratch ,damage on polarizer, Particle on polarizer or between polarizer and glass.	arizer, Particle on arizer or between Refer to item 1 and item 2.				
6	(if Polarizer is used)	Bubble, dent and convex	Α	Ф<=0.1	Neglected	Neglected	
			В	0.1 <Ф<=0.2	2	Neglected	
			С	0.2 <Ф<=0.3	1	2	
7	Surplus glass	Stage surplus glass Surrounding surplus glass	B<=0.3mm Should not influence outline dimension and assembling.				
8	Open segment or o	open common	Not permitted				
9	Short circuit			permitted			
10	False viewing direction			t permitted			
11	Contrast ratio uneven			According to the limit specimen			
12	Crosstalk			According to the limit specimen			
13	Black /White spot(cisplay)			Refer to item 1			
14	Black /White line(display)			fer to item 2			

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Inspection items			Judgment standard			
		moposion tome	Category(application: B zone)			
16	PCB defect	Component soldering: No cold soldering short open circuit burn tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald. Serious cave distortion on plug and socket contact pin is not permitted	Soldering pad Lead Component Livo Livo			
		Glue on root of the speaker receiver and motor lead: The insulative coat of the lead must join into the PCB; the protected glue must envelop to the insulative coat.	Glue Lead PCB Insulative coat			

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10. Precautions for Use of LCD Modules

10.1 Handling Precautions

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohel/
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

Watel

ketone

— Aromatic solvents

- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.

- c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range.

 If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C $\sim 40^{\circ}$ C

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

